



NCE N-Channel Enhancement Mode Power MOSFET



The NCE0170 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

GENERAL FEATURES

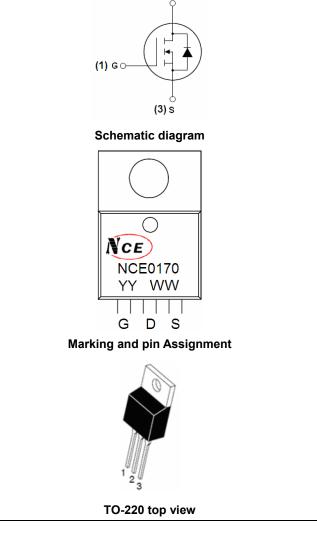
- $V_{DS} = 100V, I_D = 70A$ $R_{DS(ON)} < 14m\Omega @ V_{GS} = 10V$ (Typ:10.5m Ω)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

100% UIS TESTED!

100% ΔVds TESTED!



(2) D

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0170	NCE0170	TO-220	-	-	-

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	70	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	50	А
Pulsed Drain Current	I _{DM}	280	А
Maximum Power Dissipation	PD	190	W
Derating factor		1.27	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	600	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJC}	0.79	°C/W
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Electrical Characteristics (TA=25°C unless otherwise noted)

Off CharacteristicsDrain-Source Breakdown Voltage BV_{DSS} $V_{GS}=0V I_D=250\muA$ 100110Zero Gate Voltage Drain Current I_{DSS} $V_{DS}=100V, V_{GS}=0V$ Gate-Body Leakage Current I_{GSS} $V_{GS}=\pm20V, V_{DS}=0V$ On Characteristics (Note 3) $V_{GS}=\pm20V, V_{DS}=0V$ Gate Threshold Voltage $V_{GS(th)}$ $V_{DS}=V_{GS, ID}=250\muA$ 23Drain-Source On-State Resistance $R_{DS(0N)$ $V_{GS}=10V, I_D=28A$ -10.5Forward Transconductance g_{FS} $V_{DS}=25V, I_D=28A$ 32-Dynamic Characteristics (Note4)Input Capacitance C_{ISS} $V_{DS}=25V, V_{GS}=0V, F=1.0MHz$ -350Reverse Transfer Capacitance C_{rss} $V_{DD}=50V, I_D=28A$ -15150Switching Characteristics (Note 4)Imput Capacitance C_{rss} -12Turn-on Delay Time $t_{d(onf)}$ $V_{DD}=50V, I_D=28A$ -55Turn-Off Delay Time $t_{d(off)}$ $V_{GS}=10V, R_{GEN}=2.5\Omega$ -45Turn-Off Fall Time t_f -470Total Gate Charge Q_q 47	- 1 ±100 4 14 -	V μA nA V mΩ S	
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Turn-Off Fall Time tf - 47 Total Gate Charge Qn - 95	-	nS	
Total Gate Charge Q _n - 95	-	nS	
Total Gate Charge Q _q - 95	-	nS	
	-	nC	
Gate-Source Charge Q_{gs} $V_{DS}=80V, I_D=28A,$ 18	-	nC	
Gate-Drain Charge Qgd VGS=10V - 25	-	nC	
Drain-Source Diode Characteristics			
Diode Forward Voltage (Note 3) V _{SD} V _{GS} =0V,I _S =28A - -	1.2	V	
Diode Forward Current (Note 2) I _S	57	A	
Reverse Recovery Time t_{rr} TJ = 25°C, IF = 28A - 140	220	nS	
Reverse Recovery ChargeQrrdi/dt = 100A/µs(Note3)-650	1000	nC	
Forward Turn-On Time ton Intrinsic turn-on time is negligible (turn-on is do	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)		

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25 Ω



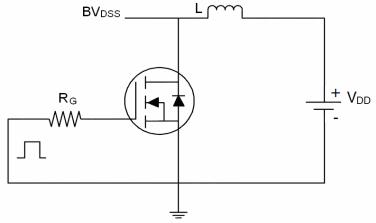
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Pb Free Product

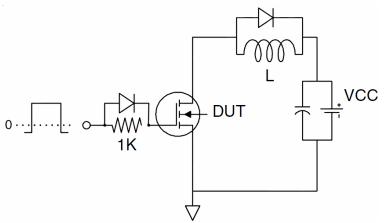


Test circuit

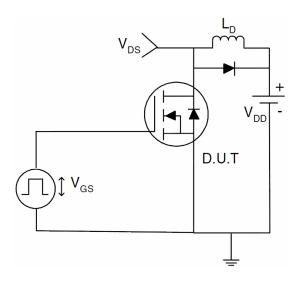
1) E_{AS} test Circuits



2) Gate charge test Circuit:



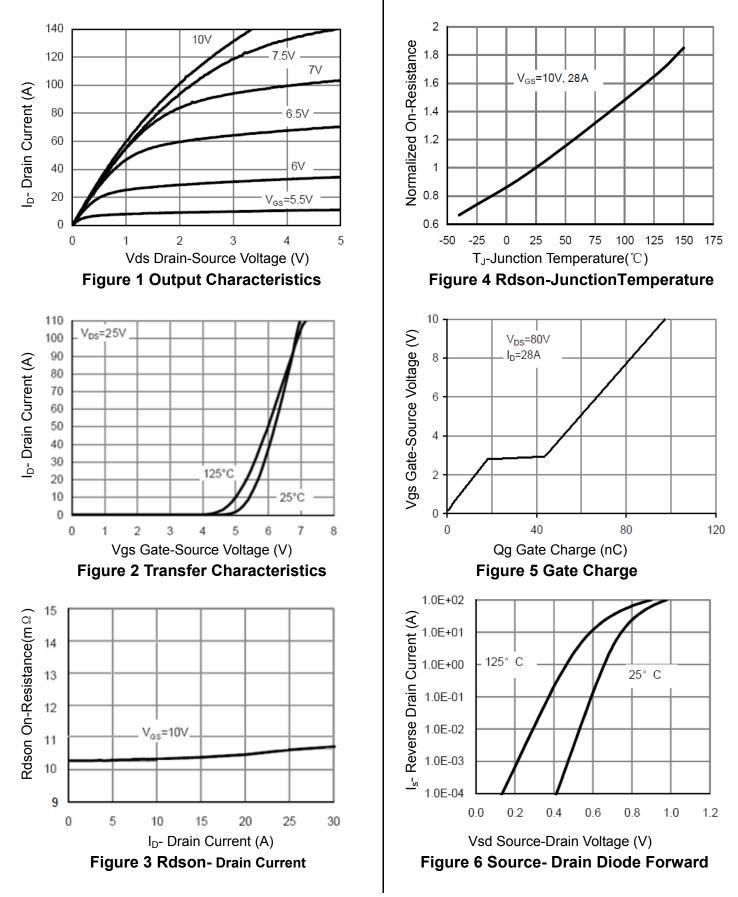
3) Switch Time Test Circuit:





NCE0170

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)





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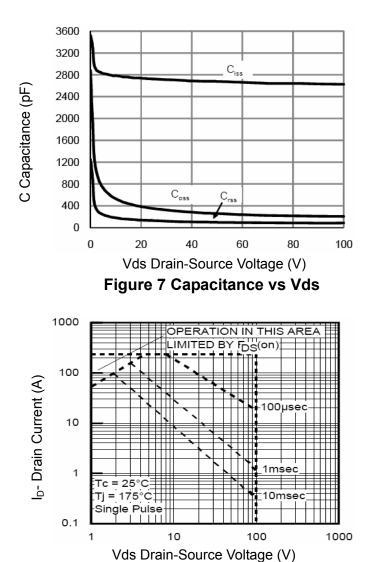


Figure 8 Safe Operation Area

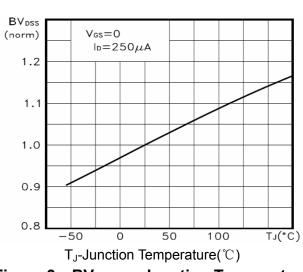


Figure 9 BV_{DSS} vs Junction Temperature

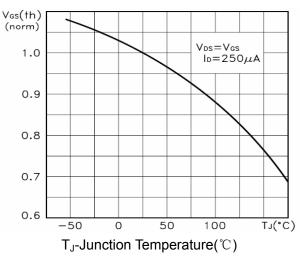
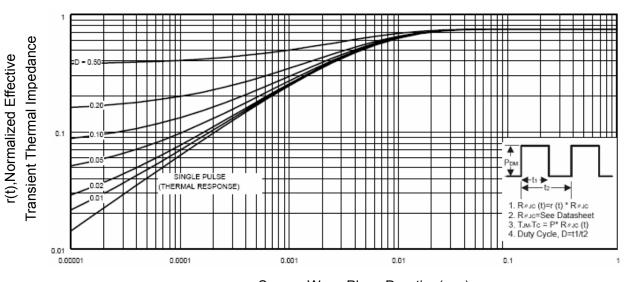


Figure 10 V_{GS(th)} vs Junction Temperatur



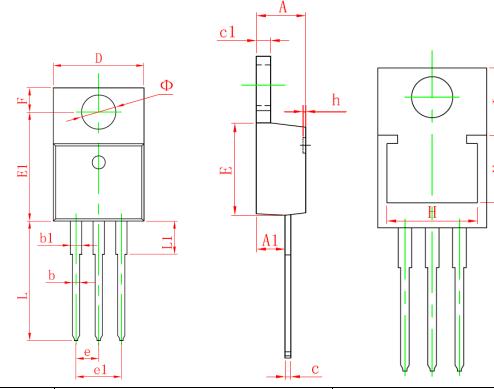
Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance





NCE0170

TO-220-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	4.470	4.670	0.176	0.184	
A1	2.520	2.820	0.099	0.111	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	10.010	10.350	0.394	0.407	
Ε	8.500	8.900	0.335	0.350	
E1	12.060	12.460	0.475	0.491	
e	2.540 (TYP.)		0.100 (TYP.)		
e1	4.980	5.180	0.196	0.204	
F	2.590	2.890	0.102	0.114	
Н	8.440 REF.		0.332 REF.		
h	0.000	0.300	0.000	0.012	
L	13.400	13.800	0.528	0.543	
L1	3.560	3.960	0.140	0.156	
V	6.360 REF.		0.250 REF.		
Ι	6.300 REF.		0.248 REF.		
Φ	3.735	3.935	0.147	0.155	



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